

ADVANCE **CYW4390**

WICED™ Wi-Fi IEEE 802.11 b/g/n SoC with Embedded Application Processor

The Cypress CYW4390 is a single-chip device that provides the highest level of integration for applications targeting the Internet of Things and provides a complete embedded wireless system solution included in a system-on-a-chip (SOC). The CYW4390 device supports all the rates specified in the IEEE 802.11 b/g/n specifications. Included on-chip are an ARM Cortex-based applications processor, single stream IEEE 802.11n MAC/baseband/radio, a 2.4 GHz transmit power amplifier (PA), and a receive low-noise amplifier (LNA). It also supports optional antenna diversity for improved RF performance in difficult environments.

CYW4390 is an optimized SoC targeting embedded applications in the industrial and medical sensor, home appliances and, generally, internet-of-things space.

Using advanced design techniques and process technology to reduce active and idle power, the CYW4390 is designed to address the needs of embedded devices that require minimal power consumption and compact size.

It includes a power management unit which simplifies the system power topology and allows for direct operation from a battery for battery powered applications while maximizing battery life.

Cypress Part Numbering Scheme

Cypress is converting the acquired IoT part numbers from Broadcom to the Cypress part numbering scheme. Due to this conversion, there is no change in form, fit, or function as a result of offering the device with Cypress part number marking. The table provides Cypress ordering part number that matches an existing IoT part number.

Table 1. Mapping Table for Part Number between Broadcom and Cypress

Acronyms and Abbreviations

In most cases, acronyms and abbreviations are defined on first use.

For a comprehensive list of acronyms and other terms used in Cypress documents, go to [http://www.cypress.com/glossary.](http://www.cypress.com/glossary)

Features

General Features

- Supports battery voltage range from 3.0V to 5.25V supplies with internal switching regulator.
- Programmable dynamic power management

Key IEEE 802.11x Features

- IEEE 802.11n compliant
- Single-stream spatial multiplexing up to 72 Mbps data rate
- Supports 20 MHz channels with optional SGI.
- Full IEEE 802.11 b/g legacy compatibility with enhanced performance
- Tx and Rx low-density parity check (LDPC) support for improved range and power efficiency
- On-chip power and low-noise amplifiers.
- Internal fractional nPLL allows support for a wide range of reference clock frequencies.
- 6k-bit OTP for storing board parameters
- Package options: 286 bump WLCSP (4.87 mm x 5.413 mm; 0.2 mm pitch)
- Supports IEEE 802.15.2 external coexistence interface to optimize bandwidth utilization with other co-located wireless technologies such as Bluetooth, LTE, GPS, or WiMAX.
- Integrated ARMCR4™ processor with tightly coupled memory for complete WLAN subsystem functionality, minimizing the need to wake up the applications processor for standard WLAN functions (to further minimize power consumption while maintaining the ability to upgrade to future features in the field)
- Software architecture supported by standard WICED SDK to allow easy migration from existing discrete MCU designs and to future devices

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- Security support:
	- ❐ WPA™ and WPA2™ (Personal) support for powerful encryption and authentication
	- ❐ AES and TKIP in hardware for faster data encryption and IEEE 802.11i compatibility

Application Processor Features

- ❐ Reference WLAN subsystem provides Cisco® Compatible Extensions (CCX, CCX 2.0, CCX 3.0, CCX 4.0, CCX 5.0)
- ❐ Supports Wi-Fi Protected Setup and Wi-Fi Easy-Setup
- Worldwide regulatory support: Global products supported with worldwide homologated design

■ ARM Cortex-M3 32-bit RISC processor ■ 448 KB RAM for application code and data execution

IoT Resources

Cypress provides a wealth of data at <http://www.cypress.com/internet-things-iot> to help you to select the right IoT device for your design, and quickly and effectively integrate the device into your design. Cypress provides customer access to a wide range of information, including technical documentation, schematic diagrams, product bill of materials, PCB layout information, and software updates. Customers can acquire technical documentation and software from the Cypress Support Community website (http://community.cypress.com/).

Contents

1. Overview

1.1 Overview

The Cypress CYW4390 is a single-chip device that provides the highest level of integration for an embedded system-on-a-chip with integrated IEEE 802.11 b/g/n MAC/baseband/radio and a separate ARM-Cortex M3 applications processor. It provides a small formfactor solution with minimal external components to drive down cost for mass volumes and allows for an embedded system with flexibility in size, form, and function. Comprehensive power management circuitry and software ensure the system can meet the needs of highly embedded systems that require minimal power consumption and reliable operation.

[Figure 2](#page-3-3) shows the interconnect of all the major physical blocks in the CYW4390 and their associated external interfaces, which are described in greater detail in the following sections.

1.2 Features

The CYW4390 supports the following features:

- ARM Cortex-M3 clocked at 48 MHz
- 448 KB of SRAM available for the applications processor
- Two high-speed 4-wire UART interfaces with operation up to 4 Mbps
- Two low-speed 2-wire UART interfaces
- One generic SPI master/slave interface with operation up to 24 MHz
- One SPI master interface for serial flash
- One I²C interface
- \blacksquare One I²S interface
- 24 x GPIOs (12 dedicated, 12 with alternate functions)
- IEEE 802.11 b/g/n 1x1 2.4 GHz radio
- Single- and dual-antenna support

1.3 Standards Compliance

The CYW4390 supports the following standards:

- IEEE 802.11n
- IEEE 802.11b
- IEEE 802.11g
- IEEE 802.11d
- IEEE 802.11h
- IEEE 802.11i
- Security:
	- ❐ WEP
	- ❐ WPA™ Personal
	- ❐ WPA2™ Personal
	- ❐ WMM ❐ WMM-PS (U-APSD)
	-
	- ❐ WMM-SA
	- ❐ AES (hardware accelerator)
	- ❐ TKIP (hardware accelerator) ❐ CKIP (software support)
- Proprietary Protocols:
	- ❐ CCXv2
	- ❐ CCXv3
	- ❐ CCXv4
	- ❐ CCXv5
	- ❐ WFAEC

The CYW4390 supports the following additional standards:

- IEEE 802.11r—fast roaming (between APs)
- IEEE 802.11w-secure management frames
- IEEE 802.11 Extensions:
	- ❐ IEEE 802.11e QoS enhancements (as per the WMM® specification is already supported)
	- ❐ IEEE 802.11i MAC enhancements
	- ❐ IEEE 802.11k radio resource measurement

2. Power Supplies and Power Management

2.1 CYW4390 PMU Features

- VBAT to 1.35Vout (275 mA nominal, 600 mA maximum) Core-Buck (CBUCK) switching regulator
- VBAT to 3.3Vout (200 mA nominal, 450 mA maximum) LDO3P3
- 1.35V to 1.2Vout (100 mA nominal, 150 mA maximum) LNLDO
- 1.35V to 1.2out (175 mA nominal, 300 mA maximum) CLDO with bypass mode for deep sleep
- Additional internal LDOs (not externally accessible)

2.2 Power Supply Topology

One buck regulator, multiple LDO regulators, and a power management unit (PMU) are integrated into the CYW4390. All regulators are programmable via the PMU. These blocks simplify power supply design for embedded designs.

A single VBAT (3.0V to 5.25V DC max) and VIO supply (1.8V to 3.3V) can be used, with all additional voltages being provided by the regulators in the CYW4390.

Two control signals, APPS_REG_ON and WL_REG_ON, are used to power-up the regulators and take the respective core out of reset. The CBUCK CLDO and LNLDO power up when any of the reset signals are deasserted. All regulators are powered down only when both APPS_REG_ON and WL_REG_ON are deasserted. The applications processor can drive WL_REG_ON internally when the pin is externally tied to ground. The CLDO and LNLDO may be turned off/on based on the dynamic demands of the application.

The CYW4390 allows for an extremely low power-consumption mode by completely shutting down the CBUCK, CLDO, and LNLDO regulators. When in this state, LPLDO1 and LPLDO2 (which are low-power linear regulators that are supplied by the system VIO supply) provide the CYW4390 with all the voltages it requires, further reducing leakage currents.

[Figure 3](#page-6-0) shows the regulators and a typical power topology.

2.3 Power Management

The CYW4390 has been designed with the stringent power consumption requirements of embedded devices in mind. All areas of the chip design are optimized to minimize power consumption. Silicon processes and cell libraries were chosen to reduce leakage current and supply voltages. Additionally, the CYW4390 integrated RAM is a high Vt memory with dynamic clock control. The dominant supply current consumed by the RAM is leakage current only. The CYW4390 also includes an advanced WLAN power management unit (PMU) sequencer. The PMU sequencer provides significant power savings by putting the CYW4390 into various power management states appropriate to the current environment and activities that are being performed. The power management unit enables and disables internal regulators, switches, and other blocks based on a computation of the required resources and a table that describes the relationship between resources and the time needed to enable and disable them. Power up sequences are fully programmable. Configurable, free-running counters (running at 32.768 kHz LPO clock) in the PMU sequencer are used to turn on/turn off individual regulators and power switches. Clock speeds are dynamically changed (or gated altogether) for the current mode. Slower clock speeds are used wherever possible.

The CYW4390 WLAN-specific power states are described as follows:

- Active mode— All WLAN blocks in the CYW4390 are powered up and fully functional with active carrier sensing and frame transmission and receiving. All required regulators are enabled and put in the most efficient mode based on the load current. Clock speeds are dynamically adjusted by the PMU sequencer.
- Doze mode—The radio, analog domains, and most of the linear regulators are powered down. The rest of the WLAN portion of the CYW4390 remains powered up in an IDLE state. All main clocks (PLL, crystal oscillator or TCXO) are shut down to reduce active power to the minimum. The 32.768 kHz LPO clock is available only for the PMU sequencer. This condition is necessary to allow the PMU sequencer to wake up the chip and transition to Active mode. In Doze mode, the primary power consumed by the WLAN core is due to leakage current.
- Deep-sleep mode—Most of the chip including both analog and digital domains and most of the regulators are powered off. Logic states in the digital core are saved and preserved into a retention memory in the always-ON domain before the digital core is powered off. Upon a wake-up event triggered by the PMU timers or an external interrupt, logic states in the digital core are restored to their pre-deep-sleep settings to avoid lengthy HW reinitialization.
- Power-down mode—The CYW4390 is effectively powered off by shutting down all internal regulators. The chip is brought out of this mode by external logic re-enabling the internal regulators.

The CYW4390 application processor subsystem can be independently powered on or off at the system level in the power-down mode. In addition it is also possible to keep the application processor in active mode while the WLAN blocks are in Doze or Deep-Sleep.

2.4 PMU Sequencing

The PMU sequencer is responsible for minimizing system power consumption. It enables and disables various system resources based on a computation of the required resources and a table that describes the relationship between resources and the time needed to enable and disable them.

Resource requests may come from several sources: clock requests from cores, the minimum resources defined in the ResourceMin register, and the resources requested by any active resource request timers. The PMU sequencer maps clock requests into a set of resources required to produce the requested clocks.

Each resource is in one of four states: enabled, disabled, transition on, and transition off and has a timer that contains 0 when the resource is enabled or disabled and a non-zero value in the transition states. The timer is loaded with the time_on or time_off value of the resource when the PMU determines that the resource must be enabled or disabled. That timer decrements on each 32.768 kHz PMU clock. When it reaches 0, the state changes from transition_off to disabled or transition_on to enabled. If the time_on value is 0, the resource can go immediately from disabled to enabled. Similarly, a time off value of 0 indicates that the resource can go immediately from enabled to disabled. The terms enable sequence and disable sequence refer to either the immediate transition or the timer load-decrement sequence.

During each clock cycle, the PMU sequencer performs the following actions:

- Computes the required resource set based on requests and the resource dependency table.
- Decrements all timers whose values are non zero. If a timer reaches 0, the PMU clears the ResourcePending bit for the resource and inverts the ResourceState bit.
- Compares the request with the current resource status and determines which resources must be enabled or disabled.
- Initiates a disable sequence for each resource that is enabled, no longer being requested, and has no powered up dependents.
- Initiates an enable sequence for each resource that is disabled, is being requested, and has all of its dependencies enabled.

2.5 Power-Off Shutdown

The CYW4390 provides a low-power shutdown feature that allows the device to be turned off. When the CYW4390 is not needed in the system, VDDIO_RF and VDDC are shut down while VDDIO remains powered. This allows the CYW4390 to be effectively off while keeping the I/O pins powered so that they do not draw extra current from any other devices connected to the I/O.

During a low-power shut-down state, provided VDDIO remains applied to the CYW4390, all outputs are tristated, and most inputs signals are disabled. Input voltages must remain within the limits defined for normal operation. This is done to prevent current paths or create loading on any digital signals in the system, and enables the CYW4390 to be fully integrated in an embedded device and take full advantage of the lowest power-savings modes.

When the CYW4390 is powered on from this state, it is the same as a normal power-up and the device does not retain any information about its state from before it was powered down.

2.6 Power-Up/Power-Down/Reset Circuits

The CYW4390 has two signals (see [Table 2](#page-8-2)) that enable or disable the application CPU and WLAN subsystems and the internal regulator blocks, allowing external system circuitry to control power consumption. For timing diagrams of these signals and the required power-up sequences, see [Power-Up Sequence and Timing on page 56](#page-55-0).

Table 2. Power-Up/Power-Down/Reset Control Signals

3. Frequency References

An external crystal is used for generating all radio frequencies and normal operation clocking. As an alternative, an external frequency reference may be used. In addition, a low-power oscillator (LPO) is provided for lower power mode timing.

3.1 Crystal Interface and Clock Generation

The CYW4390 can use an external crystal to provide a frequency reference. The recommended configuration for the crystal oscillator including all external components is shown in [Figure 4](#page-9-3). Consult the reference schematics for the latest configuration.

Figure 4. Recommended Oscillator Configuration

A fractional-N synthesizer in the CYW4390 generates the radio frequencies, clocks, and data/packet timing, enabling it to operate using a wide selection of frequency references.

The recommended default frequency reference is a 37.4 MHz crystal. The signal characteristics for the crystal interface are listed in [Table 3 on page 11](#page-10-0).

Note: Although the fractional-N synthesizer can support alternative reference frequencies, frequencies other than the default require support to be added in the driver, plus additional extensive system testing. Contact Cypress for further details.

3.2 External Frequency Reference

As an alternative to a crystal, an external precision frequency reference can be used, provided that it meets the Phase Noise requirements listed in [Table 3.](#page-10-0)

If used, the external clock should be connected to the WRF_XTAL_IN pin through an external 1000 pF coupling capacitor, as shown in [Figure 5](#page-9-4). The internal clock buffer connected to this pin will be turned OFF when the CYW4390 goes into sleep mode. When the clock buffer turns ON and OFF there will be a small impedance variation. Power must be supplied to the WRF_XTAL_BUCK_VDD1P5 pin.

Figure 5. Recommended Circuit to Use with an External Reference Clock

Table 3. Crystal Oscillator and External Clock – Requirements and Performance

a. (Crystal) Use WRF_XTAL_IN and WRF_XTAL_OUT.

b. See [External Frequency Reference on page 10](#page-9-2) for alternative connection methods.
c. For a clock reference other than 37.4 MHz, 20 × log10(f/ 37.4) dB should be added to the limits, where f = the reference clock frequ

d. The frequency step size is approximately 80 Hz resolution.

e. It is the responsibility of the equipment designer to select oscillator components that comply with these specifications. f. Assumes that external clock has a flat phase noise response above 100 kHz.

3.3 External 32.768 KHz Low-Power Oscillator

The CYW4390 uses a secondary low frequency clock for low-power-mode timing. Either the internal low-precision LPO or an external 32.768 kHz precision oscillator is required. The internal LPO frequency range is approximately 33 kHz ± 30% over process, voltage, and temperature, which is adequate for some applications. However, one trade-off caused by this wide LPO tolerance is a small current consumption increase during power save mode that is incurred by the need to wake up earlier to avoid missing beacons.

Whenever possible, the preferred approach is to use a precision external 32.768 kHz clock that meets the requirements listed in [Figure](#page-11-1) [4 on page 12](#page-11-1).

The external 32.768 kHz crystal provides:

- A real-time clock for the apps core
- Accurate timing for the WLAN power-save modes

Table 4. External 32.768 kHz Sleep Clock Specifications

a. When power is applied or switched off.

4. Applications Microprocessor and Memory Unit

The applications microprocessor core is based on the ARM® Cortex-M3™ 32-bit RISC processor with embedded ICE-RT debug and JTAG interface units.

The applications processor boots from an internal ROM-based bootloader. The ROM bootloader copies a configurable boot application from serial-flash to RAM, then passes execution to the boot application. The applications processor is responsible for running the entirety of the WICED software stack, including the optional RTOS, WLAN driver, various libraries to implement WLAN, networking features, and the end-user application.

The 48 MHz processor operates efficiently in both power and performance with tightly-coupled SRAM of 448 KB to provide space for code execution and system resource and variable storage.

The application processor controls the peripheral I/O of the CYW4390, including a dedicated SPI flash interface, SPI master/slave interface, GPIOs, ${}^{12}C$, I₂S, and four UARTs. The application processor is also responsible for bootstrapping the WLAN core, including downloading the WLAN firmware from external serial flash storage.

The CYW4390 does not have internal flash storage: all code is stored and loaded from external serial flash.

In addition to the dedicated SPI interface to serial flash, the CYW4390 provides a secondary master/slave SPI interface to allow expansion with other devices.

To reduce overall system power consumption, the application processor can be powered down independently of the WLAN core. During powerdown, the state of the entire 448 KB of Applications RAM is retained.

4.1 Reset

The CYW4390 has an integrated power-on reset circuit that resets all circuits to a known power-on state. The power-on reset (POR) circuit is out of reset after APPS_REG_ON goes High. If APPS_REG_ON is low, then the POR circuit is held in reset.

5. Applications Microprocessor Subsystem External Interfaces

5.1 Introduction

The CYW4390 provides a large variety of IO interfaces to enable flexible system design:

- A SPI master for flash access
- A SPI master/slave
- Two high-speed 4-wire UARTs
- Two 2-wire UART available for use by the Apps core (and WLAN core for debugging)
- \blacksquare An I²C interface
- \blacksquare An I²S interface
- Up to 24 GPIOs organized in two separate banks of 12. GPIOs in Bank A have alternate functions (see [Table 5 on page 15](#page-14-0)), GPIOs in Bank B are dedicated.

Table 5. GPIO Port A Alternate Functions

5.2 SPI Flash Interface

The CYW4390 provides a dedicated SPI interface that connects to an external serial flash with a maximum clock speed of 24 MHz. Use of the SPI flash interface is mandatory for self-hosted systems booting an application that runs on the Application processor.

5.2.1 SPI Master/Slave Interface

In addition to the SPI flash interface the CYW4390 supports a secondary SPI interface with a clock frequency of up to 24 MHz to support external SPI peripherals. This interface can be configured either as a master or a slave interface. The SPI interface has various configuration options including support for active-low or active-high operation for the chip-select, active-low or active-high operation for the interrupt line and bit ordering on the MISO/MOSI lines to be either big endian or little endian.

5.3 UART Interfaces

UART1 and UART2 have standard 4-wire interfaces (RX, TX, RTS, and CTS) with adjustable baud rates from 9600 bps to 4.0 Mbps.

UART1 has a 1040-byte receive FIFO and a 1040-byte transmit FIFO to support high data throughput. UART2 has a smaller FIFO that is only 256-bytes. Access to the FIFOs is available to the application processor through the AHB interface and supports either DMA or CPU driven data transfer.

The CYW4390 UART can perform XON/XOFF flow control and includes hardware support for the Serial Line Input Protocol (SLIP). It can also perform wake-on activity. For example, activity on the RX or CTS inputs can wake the chip from a sleep state.

The CYW4390 UARTs can operate correctly with other devices as long as the combined baud rate error of the two devices is within ±2%.

Table 6. Example of Common Baud Rates

The UART timing is shown by the combination of [Figure 6](#page-16-1) and [Table 7](#page-16-2).

Table 7. UART Timing Specifications

5.4 I2S Interface

The CYW4390 has one I²S digital audio port, which supports both master and slave modes.

The $I²S$ SCK and $I²S$ WS (clock and word select) become outputs in master mode and inputs in slave mode, while the I2S SDO is always output.

The channel word length is 16 bits and the data is justified so that the MSB of the left-channel data is aligned with the MSB of the I²S, per the I²S specification. The MSB of each data word is transmitted one-bit clock cycle after the I²S WS transition, synchronous with the falling edge of the bit clock.

Left-channel data is transmitted when 1^2 S WS is low: right-channel data is transmitted when 1^2 S WS is high.

Data bits sent by the CYW4390 are synchronized with the falling edge of I2S_SCLK and should be sampled by the receiver on the rising edge of I2S_SCK.

In master mode, the clock rate is: 48 KHz x 32 bits per frame = 1.536 MHz.

The master clock is generated from the input reference clock using an N/M clock divider.

In the slave mode, any clock rate up to 3.072 MHz is supported.

5.5 General Purpose Input and Output

The CYW4390 has 24 general purpose IO (GPIO) pins that can be configured as input or output. Each IO can be configured to have internal pull-up or pull-down resistors. At power-on reset all IOs are configured as input with no pull. Software can configure the IOs appropriately. In power-down modes, the IOs are configured as high-Z with no pull.

GPIOs are grouped into two banks of twelve GPIOs:

- Bank A GPIOs have alternate functions (se[eTable 5 on page 15\)](#page-14-0).
- Bank B GPIOs are dedicated GPIOs, except during test (see [Table 8\)](#page-17-2).

Table 8. Bank B GPIO Test Functions

5.6 I2C

TBD

6. WLAN Global Functions

6.1 WLAN CPU and Memory Subsystem

The CYW4390 WLAN section includes an independent integrated ARM Cortex-R4™ 32-bit processor with internal RAM and ROM. The ARM Cortex-R4 is a low-power processor that features low gate count, low interrupt latency, and low-cost debug capabilities. It runs all WLAN firmware and provides support for the standards-compliant WLAN implementation running independent of the applications processor. The Cortex-R4 processor is not available to customers for general purpose applications processing.

At 0.19 μW/MHz, the Cortex-R4 is the most power efficient general-purpose microprocessor available, outperforming 8- and 16-bit devices on MIPS/μW. It supports integrated sleep modes.

6.2 One-Time Programmable Memory

Various hardware configuration parameters may be stored in an internal 6 Kbit one-time programmable (OTP) memory, which is read by WICED bootstrap system software after a device reset. In addition, customer-specific parameters, including the system vendor ID and the MAC address can be stored, depending on the specific board design.

The initial state of all bits in an unprogrammed OTP device is 0. After any bit is programmed to a 1, it cannot be reprogrammed to 0. The entire OTP array can be programmed in a single write cycle using a utility provided with the Cypress WLAN manufacturing test tools. Alternatively, multiple write cycles can be used to selectively program specific bytes, but only bits which are still in the 0 state can be altered during each programming cycle.

Prior to OTP programming, all values should be verified using the appropriate editable nvram.txt file, which is provided with the reference board design package.

6.3 UART Interface

One 2-wire UART interface can be enabled by software as an alternate function on GPIO pins. Provided primarily for debugging during WLAN development, this UART enables the CYW4390 to operate as RS-232 data termination equipment (DTE) for exchanging and managing data with other serial devices. It is compatible with the industry standard 16550 UART, and provides a FIFO size of 64 × 8 in each direction.

6.4 JTAG Interfaces

The CYW4390 applications core and WLAN core have independent support for the IEEE 1149.1 JTAG boundary scan standard for performing application firmware debugging and device package and PCB assembly testing during manufacturing.

The applications core JTAG port provides developers with single-step thread-aware and memory inspection debugging capability using the Cypress WICED development system.

The WLAN core JTAG interface allows Cypress to assist customers by using proprietary debug and characterization test tools during board bring-up. Therefore it is highly recommended to provide access to the JTAG pins by means of test points or a header on all PCB designs.

6.5 Boot Sequence

[Figure 7](#page-19-1) shows the boot sequence from power-up to firmware download.

Figure 7. Boot Sequence

7. Wireless LAN MAC and PHY

7.1 IEEE 802.11n MAC

The CYW4390 WLAN MAC is designed to support high-throughput operation with low-power consumption. Several power saving modes have been implemented that allow the MAC to consume very little power while maintaining network-wide timing synchronization. The architecture diagram of the MAC is shown in [Figure 8](#page-20-2).

The following sections provide an overview of the important modules in the MAC.

Figure 8. WLAN MAC Architecture

The CYW4390 WLAN media access controller (MAC) supports features specified in the IEEE 802.11 base standard, and amended by IEEE 802.11n. The key MAC features include:

- Enhanced MAC for supporting IEEE 802.11n features
- Transmission and reception of aggregated MPDUs (A-MPDU) for high throughput (HT)
- Support for power management schemes, including WMM power-save, power-save multi-poll (PSMP) and multiphase PSMP operation
- Support for immediate ACK and Block-ACK policies
- Interframe space timing support, including RIFS
- Support for RTS/CTS and CTS-to-self frame sequences for protecting frame exchanges
- Back-off counters in hardware for supporting multiple priorities as specified in the WMM specification
- Timing synchronization function (TSF), network allocation vector (NAV) maintenance, and target beacon transmission time (TBTT) generation in hardware
- Hardware offload for AES-CCMP, legacy WPA TKIP, legacy WEP ciphers, WAPI, and support for key management
- Programmable independent basic service set (IBSS) or infrastructure basic service set functionality
- Statistics counters for MIB support

Programmable State Machine

The programmable state machine (PSM) is a microcoded engine, which provides most of the low-level control to the hardware, to implement the IEEE 802.11 specification. It is a microcontroller that is highly optimized for flow control operations, which are predominant in implementations of communication protocols. The instruction set and fundamental operations are simple and general, which allows algorithms to be optimized until very late in the design process. It also allows for changes to the algorithms to track evolving IEEE 802.11 specifications.

The PSM fetches instructions from the microcode memory. It uses the shared memory to obtain operands for instructions, as a data store, and to exchange data between both the host and the MAC data pipeline (via the SHM bus). The PSM also uses a scratch-pad memory (similar to a register bank) to store frequently accessed and temporary variables.

The PSM exercises fine-grained control over the hardware engines, by programming internal hardware registers (IHR). These IHRs are co-located with the hardware functions they control, and are accessed by the PSM via the IHR bus.

The PSM fetches instructions from the microcode memory using an address determined by the program counter, instruction literal, or a program stack. For ALU operations the operands are obtained from shared memory, scratch pad, IHRs, or instruction literals, and the results are written into the shared memory, scratch pad, or IHRs.

There are two basic branch instructions: conditional branches and ALU based branches. To better support the many decision points in the IEEE 802.11 algorithms, branches can depend on either a readily available signals from the hardware modules (branch condition signals are available to the PSM without polling the IHRs), or on the results of ALU operations.

Wired Equivalent Privacy

The wired equivalent privacy (WEP) engine encapsulates all the hardware accelerators to perform the encryption and decryption, and MIC computation and verification. The accelerators implement the following cipher algorithms: legacy WEP, WPA TKIP, and WPA2 AES-CCMP.

The PSM determines, based on the frame type and association information, the appropriate cipher algorithm to be used. It supplies the keys to the hardware engines from an on-chip key table. The WEP interfaces with the TXE to encrypt and compute the MIC on transmit frames, and the RXE to decrypt and verify the MIC on receive frames.

Transmit Engine

The transmit engine (TXE) constitutes the transmit data path of the MAC. It coordinates the DMA engines to store the transmit frames in the TXFIFO. It interfaces with WEP module to encrypt frames, and transfers the frames across the MAC-PHY interface at the appropriate time determined by the channel access mechanisms.

The data received from the DMA engines are stored in transmit FIFOs. The MAC supports multiple logical queues to support traffic streams that have different QoS priority requirements. The PSM uses the channel access information from the IFS module to schedule a queue from which the next frame is transmitted. Once the frame is scheduled, the TXE hardware transmits the frame based on a precise timing trigger received from the IFS module.

The TXE module also contains the hardware that allows the rapid assembly of MPDUs into an A-MPDU for transmission. The hardware module aggregates the encrypted MPDUs by adding appropriate headers and pad delimiters as needed.

Receive Engine

The receive engine (RXE) constitutes the receive data path of the MAC. It interfaces with the DMA engine to drain the received frames from the RXFIFO. It transfers bytes across the MAC-PHY interface and interfaces with the WEP module to decrypt frames. The decrypted data is stored in the RXFIFO.

The RXE module contains programmable filters that are programmed by the PSM to accept or filter frames based on several criteria such as receiver address, BSSID, and certain frame types.

The RXE module also contains the hardware required to detect A-MPDUs, parse the headers of the containers, and disaggregate them into component MPDUS.

Interframe Space

The interframe space (IFS) module contains the timers required to determine interframe space timing including RIFS timing. It also contains multiple backoff engines required to support prioritized access to the medium as specified by WMM.

The interframe spacing timers are triggered by the cessation of channel activity on the medium, as indicated by the PHY. These timers provide precise timing to the TXE to begin frame transmission. The TXE uses this information to send response frames or perform transmit frame-bursting (RIFS or SIFS separated, as within a TXOP).

The backoff engines (for each access category) monitor channel activity, in each slot duration, to determine whether to continue or pause the backoff counters. When the backoff counters reach 0, the TXE gets notified, so that it may commence frame transmission. In the event of multiple backoff counters decrementing to 0 at the same time, the hardware resolves the conflict based on policies provided by the PSM.

The IFS module also incorporates hardware that allows the MAC to enter a low-power state when operating under the IEEE power save mode. In this mode, the MAC is in a suspended state with its clock turned off. A sleep timer, whose count value is initialized by the PSM, runs on a slow clock and determines the duration over which the MAC remains in this suspended state. Once the timer expires the MAC is restored to its functional state. The PSM updates the TSF timer based on the sleep duration ensuring that the TSF is synchronized to the network.

Timing Synchronization Function

The timing synchronization function (TSF) module maintains the TSF timer of the MAC. It also maintains the target beacon transmission time (TBTT). The TSF timer hardware, under the control of the PSM, is capable of adopting timestamps received from beacon and probe response frames in order to maintain synchronization with the network.

The TSF module also generates trigger signals for events that are specified as offsets from the TSF timer, such as uplink and downlink transmission times used in PSMP.

Network Allocation Vector

The network allocation vector (NAV) timer module is responsible for maintaining the NAV information conveyed through the duration field of MAC frames. This ensures that the MAC complies with the protection mechanisms specified in the standard.

The hardware, under the control of the PSM, maintains the NAV timer and updates the timer appropriately based on received frames. This timing information is provided to the IFS module, which uses it as a virtual carrier-sense indication.

MAC-PHY Interface

The MAC-PHY interface consists of a data path interface to exchange RX/TX data from/to the PHY. In addition, there is an programming interface, which can be controlled either by the host or the PSM to configure and control the PHY.

7.2 IEEE 802.11n PHY

The CYW4390 WLAN Digital PHY is designed to comply with IEEE 802.11 b/g/n single-stream specifications to provide wireless LAN connectivity supporting data rates from 1 Mbps to 72 Mbps for low-power, high-performance embedded applications.

The PHY has been designed to work in the presence of interference, radio nonlinearity, and various other impairments. It incorporates optimized implementations of the filters, FFT and Viterbi decoder algorithms. Efficient algorithms have been designed to achieve maximum throughput and reliability, including algorithms for carrier sense/rejection, frequency/phase/timing acquisition and tracking, channel estimation and tracking. The PHY receiver also contains a robust IEEE 802.11b demodulator. The PHY carrier sense has been tuned to provide high throughput for IEEE 802.11g/11b hybrid networks.

The key PHY features include:

- Programmable data rates in 20 MHz channels, as specified in IEEE 802.11n
- Supports Optional Short GI and Green Field modes in Tx and Rx
- Tx and Rx LDPC for improved range and power efficiency
- All scrambling, encoding, forward error correction, and modulation in the transmit direction and inverse operations in the receive direction.
- Supports IEEE 802.11h/k for worldwide operation
- Advanced algorithms for low power, enhanced sensitivity, range, and reliability
- Automatic gain control scheme for blocking and non blocking application scenario for cellular applications
- Closed loop transmit power control
- Digital RF chip calibration algorithms to handle CMOS RF chip non-idealities
- On-the-fly channel frequency and transmit power selection
- Supports per packet Rx antenna diversity
- Available per-packet channel quality and signal strength measurements
- Designed to meet FCC and other worldwide regulatory requirements

[Figure 9 on page 25](#page-24-0) is a block diagram of the WLAN PHY.

CYW4390

8. WLAN Radio Subsystem

The CYW4390 includes an integrated single-band WLAN RF transceiver that has been optimized for use in 2.4 GHz WLAN systems. It has been designed to provide low-power, low-cost, and robust communications for applications operating in the globally available 2.4 GHz unlicensed ISM band. The transmit and receive sections include all on-chip filtering, mixing, and gain control functions.

A block diagram of the radio subsystem is shown in [Figure 10.](#page-25-4) Note that integrated on-chip baluns (not shown) convert the fully differential transmit and receive paths to single-ended signal pins.

Figure 10. Radio Functional Block Diagram

8.1 Receiver Path

The CYW4390 has a wide dynamic range, direct conversion receiver that employs high order on-chip channel filtering to ensure reliable operation in the noisy 2.4 GHz ISM band. The 2.4 GHz receive path has a dedicated on-chip low-noise amplifier (LNA).

8.2 Transmit Path

Baseband data is modulated and upconverted to the 2.4 GHz ISM band, respectively. Linear on-chip power amplifiers are included, which are capable of delivering high output powers while meeting IEEE 802.11 b/g/n specifications without the need for external PAs. When using the internal PAs, closed-loop output power control is completely integrated.

8.3 Calibration

The CYW4390 features dynamic and automatic on-chip calibration to continually compensate for temperature and process variations across components. These calibration routines are performed periodically in the course of normal radio operation. Examples of some of the automatic calibration algorithms are baseband filter calibration for optimum transmit and receive performance, and LOFT calibration for carrier leakage reduction. In addition, I/Q Calibration, R Calibration, and VCO Calibration are performed on-chip. No per-board calibration is required in manufacturing test, which helps to minimize the test time and cost in large volume production.

9. Pinout and Signal Descriptions

9.1 Ball Maps

[Figure 11](#page-26-2) shows the WLCSP bump map.

Figure 11. 286-Bump WLCSP (Bottom View, Bumps Facing Up)

9.2 Pin Lists

[Table 9](#page-27-1) contains the 286-bump WLCSP coordinates.

Table 9. 286-**Bump WLCSP Coordinates**

9.3 Signal Descriptions

The signal name, type, and description of each pin in the CYW4390 are listed in [Table 10](#page-35-1). The symbol listed in the Type column indicates the pin direction (I/O = bidirectional, I = input, O = output) and the internal pull-up/pull-down characteristics, if any (PU = weak internal pull-up resistor and PD = weak internal pull-down resistor).

Table 10. WLCSP and FCFBGA Pin Descriptions

Table 10. WLCSP and FCFBGA Pin Descriptions (Cont.)

Table 10. WLCSP and FCFBGA Pin Descriptions (Cont.)

Table 10. WLCSP and FCFBGA Pin Descriptions (Cont.)

9.4 I/O States

The following notations are used in [Table](#page-39-1) 11:

- I: Input signal
- O: Output signal
- I/O: Input/Output signal
- PU = Pulled up
- PD = Pulled down
- NoPull = Neither pulled up nor pulled down

Table 11. I/O States

Table 11. I/O States (Cont.)

a. Keeper column: N = pad has no keeper. Y = pad has a keeper. Keeper is always active except in Power-down state. If there is no keeper, and it is an input and there is Nopull, then the pad should be driven to prevent leakage due to floating pad (SDIO_CLK, for example).

b. In the Power-down state (xx_REG_ON=0): High-Z; NoPull => the pad is disabled because power is not supplied.

10. DC Characteristics

Note: Values in this data sheet are design goals and are subject to change based on the results of device characterization.

10.1 Absolute Maximum Ratings

Caution: The absolute maximum ratings in [Table 12](#page-41-4) indicate levels where permanent damage to the device can occur, even if these limits are exceeded for only a brief duration. Functional operation is not guaranteed under these conditions. Operation at absolute maximum conditions for extended periods can adversely affect long-term reliability of the device.

Table 12. Absolute Maximum Ratings

10.2 Environmental Ratings

The environmental ratings are shown in [Table 13.](#page-41-3)

Table 13. Environmental Ratings

a. Functionality is guaranteed but specifications require derating at extreme temperatures; see the specification tables for details.

10.3 Electrostatic Discharge Specifications

Extreme caution must be exercised to prevent electrostatic discharge (ESD) damage. Proper use of wrist and heel grounding straps to discharge static electricity is required when handling these devices. Always store unused material in its antistatic packaging.

Table 14. ESD Specifications

10.4 Recommended Operating Conditions and DC Characteristics

Caution: Functional operation is not guaranteed outside of the limits shown in [Table 15 on page 44](#page-43-1) and operation outside these limits for extended periods can adversely affect long-term reliability of the device.

a. The CYW4390 is functional across this range of voltages. Optimal RF performance specified in the data sheet, however, is guaranteed only for 3.13V < VBAT < 4.8V. b. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration over the lifetime of the device are allowed. Voltages as high
as 5.5V for up to 250 seconds, cumulative duration ove

c. Programmable 2 mA to 16 mA drive strength. Default is 10 mA.

11. WLAN RF Specifications

11.1 Introduction

The CYW4390 includes an integrated single-band direct conversion radio that supports the 2.4 GHz band. This section describes the RF characteristics of the 2.4 GHz radio.

Note: Values in this section of the data sheet are design goals and are subject to change based on the results of device characterization.

Unless otherwise stated, limit values apply for the conditions specified in[Table 13 on page 42](#page-41-3) and [Table 15 on page 44](#page-43-1). Typical values apply for the following conditions:

\blacksquare VBAT = 3.6V

■ Ambient temperature +25°C

Figure 12. Port Locations

Note: All WLAN specifications are specified at the chip port, unless otherwise specified.

11.2 2.4 GHz Band General RF Specifications

Table 16. 2.4 GHz Band General RF Specifications

11.3 WLAN 2.4 GHz Receiver Performance Specifications

Note: The specifications in [Table 17](#page-45-1) are specified at the chip port, unless otherwise specified.

Table 17. WLAN 2.4 GHz Receiver Performance Specifications (Cont.)

a. Derate by 1.5 dB for –30°C to –10°C and 55°C to 85°C. b. Sensitivity degradations for alternate settings in MCS modes. MM: 0.5 dB drop, and SGI: 2 dB drop.

c. The cellular standard listed for each band indicates the type of modulation used to generate the interfering signal in that band for the purpose of this test. It is not intended

to indicate any specific usage of each band in any specific country.
d. The blocking levels are valid for channels 1 to 11. (For higher channels, the performance may be lower due to third harmonic signals (3 × 824 MHz) fal e. The minimum and maximum values shown have a 95% confidence level.

11.4 WLAN 2.4 GHz Transmitter Performance Specifications

Note: The specifications in [Table 18](#page-47-1) are specified at the chip port output, unless otherwise specified.

Table 18. WLAN 2.4 GHz Transmitter Performance Specifications

a. Derate by 1.5 dB for temperatures less than -10°C or more than 55°C, or voltages less than 3.0V. Derate by 3.0 dB for voltages of less than 2.7V, or voltages of less than 3.0V at temperatures less than –10°C or greater than 55°C. Derate by 4.5 dB for –40°C to –30°C.

b. Tx power for Channel 1 and Channel 11 is specified by non-volatile memory parameters.

11.5 General Spurious Emissions Specifications

Table 19. General Spurious Emissions Specifications

a. For frequencies other than 3.2 GHz, the emissions value is –96 dBm. The value presented in table is the result of LO leakage at 3.2 GHz.

12. Internal Regulator Electrical Specifications

Note: Values in this data sheet are design goals and are subject to change based on the results of device characterization.

Functional operation is not guaranteed outside of the specification limits provided in this section.

12.1 Core Buck Switching Regulator

Table 20. Core Buck Switching Regulator (CBUCK) Specifications

a. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as high as 5.5V for up to 250 seconds, cumulative duration, over the lifetime of the device are allowed.

b. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.
c. Total capacitance includes those connected at the far end of the

12.2 3.3V LDO (LDO3P3)

Table 21. LDO3P3 Specifications

a. The maximum continuous voltage is 5.25V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as high
as 5.5V for up to 250 seconds, cumulative duration, o

b. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

12.3 CLDO

Table 22. CLDO Specifications

a. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

12.4 LNLDO

Table 23. LNLDO Specifications

a. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

13. System Power Consumption

Note: Values in this data sheet are design goals and are subject to change based on the results of device characterization.

Note: Unless otherwise stated, these values apply for the conditions specified in [Table 15 on page 44](#page-43-1).

13.1 WLAN Current Consumption

The WLAN current consumption measurements are shown in [Table 25](#page-54-2).

Table 25. Typical WLAN Power Consumptiona

a. Vio is specified with all pins idle (not switching) and not driving any loads.

b. WL_REG_ON and APPS_REG_ON are low. c. Idle, not associated or inter-beacon.

d. Beacon interval is 102.4 ms and beacon duration is 1 ms @ 1 Mbps. Average current is over three DTIM intervals.

e. Duty cycle is 100%. f. Measured using packet engine test mode.

g. Duty cycle is 100%. It includes internal PA contribution.

h. Duty cycle is 100%. Carrier sense (CS) detect/packet receive.

i. MCS7 and HT20.

j. Carrier Sense (CCA) when no carrier is present.

13.2 JTAG Timing

Table 26. JTAG Timing Characteristics

14. Power-Up Sequence and Timing

14.1 Sequencing of Reset and Regulator Control Signals

The CYW4390 has two signals that allow the host to control power consumption by enabling or disabling the APPS CPU, WLAN, and internal regulator blocks. These signals are described below. Additionally, diagrams are provided to indicate proper sequencing of the signals for various operational states (see [Figure 13](#page-56-0) and [Figure 14 on page 57](#page-56-1), and [Figure 15](#page-57-0) and [Figure 16 on page 58](#page-57-1)). The timing values indicated are minimum required values; longer delays are also acceptable.

14.1.1 Description of Control Signals

- WL_REG_ON: Used by the PMU to power up the WLAN section. It is also OR-gated with the APPS_REG_ON input to control the internal CYW4390 regulators. When this pin is high, the regulators are enabled and the WLAN section is out of reset. When this pin is low the WLAN section is in reset. If both the APPS_REG_ON and WL_REG_ON pins are low, the regulators are disabled.
- **APPS_REG_ON**: Used by the PMU (OR-gated with WL_REG_ON) to power up the internal CYW4390 regulators. If both the APPS_REG_ON and WL_REG_ON pins are low, the regulators are disabled. When this pin is low and WL_REG_ON is high, the APPS CPU section is in reset.

Note: For both the WL_REG_ON and APPS_REG_ON pins, there should be at least a 10 ms time delay between consecutive toggles (where both signals have been driven low). This is to allow time for the CBUCK regulator to discharge. If this delay is not followed, then there may be a VDDIO in-rush current on the order of 36 mA during the next PMU cold start.

Note: The CYW4390 has an internal power-on reset (POR) circuit. The device will be held in reset for a maximum of 110 ms after VDDC and VDDIO have both passed the POR threshold.

Note: VBAT should not rise 10%–90% faster than 40 microseconds. VBAT should be up before or at the same time as VDDIO. VDDIO should NOT be present first or be held high before VBAT is high.

14.1.2 Control Signal Timing Diagrams

Figure 14. WLAN = OFF, APPS CPU = OFF

Figure 15. WLAN = ON, APPS CPU = OFF

Figure 16. WLAN = OFF, APPS CPU= ON

15. Package Information

15.1 Package Thermal Characteristics

Table 27. Package Thermal Characteristics^a

a. No heat sink, TA = 70°C. This is an estimate, based on a 4-layer PCB that conforms to EIA/JESD51-7 (101.6 mm × 101.6 mm × 1.6 mm) and P = 1.119W continuous dissipation.

15.2 Junction Temperature Estimation and PSI_{JT} Versus THETA_{JC}

Package thermal characterization parameter PSI–J_T (\varPsi_{JT}) yields a better estimation of actual junction temperature (T_J) versus using the junction-to-case thermal resistance parameter Theta–J_C ($\theta_{\rm JC}$). The reason for this is that $\theta_{\rm JC}$ assumes that all the power is dissipated through the top surface of the package case. In actual applications, some of the power is dissipated through the bottom and sides of the package. \varPsi_{JT} takes into account power dissipated through the top, bottom, and sides of the package. The equation for calculating the device junction temperature is:

$$
T_J = T_T + P \times \mathcal{V}_{JT}
$$

Where:

- \blacksquare T_J = Junction temperature at steady-state condition (°C)
- \blacksquare T_T = Package case top center temperature at steady-state condition (°C)
- \blacksquare P = Device power dissipation (Watts)
- \mathbb{P}_T = Package thermal characteristics; no airflow (°C/W)

15.3 Environmental Characteristics

For environmental characteristics data, see [Table 13 on page 42](#page-41-3).

16. Mechanical Information

Figure 18. WLCSP Keep-Out Areas for PCB Layout—Bottom View, Bumps Facing Up

Note: Top-layer metal is not allowed in the keep-out areas.

17. Ordering Information

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